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DEPARTMENT GENERAL MANAGER ENGINEERING DEPERTMENT 2 RF DEVICES DIVISION ELECTRONIC COMPONENTS GROUP

SHARP			MODEL No. BS2F7VZ0164	SPEC No. EC-06X02	PAGE 2 / 19
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MODEL No. SPEC No. PAGE BS2F7VZ0164 EC-06X02 3/19

# SHARP

### **DESCRIPTION:**

This specification covers DBS tuner intended for use in Digital Broadcasting Satellites. This tuner incorporates "LINK" section that is composed of 8bit ADC, multistandard DVB-S/DVB-S2 demodulator and multistandard FEC. This tuner has DVB common interface compliant transport stream output.

## [1] GENERAL SPECIFICATIONS

1-1. Receiving frequency range 950MHz to 2150MHz

1-2. Input level -65dBm to -25dBm

1-3. Input structure F type Female

1-4. Nominal input impedance 75 ohm

1-5. Channel selection system PLL synthesizer built in tuner IC "IX2470VA"

(Address:C0h)

(Reference clock: Internal 4.0MHz crystal oscillation)

1-6. Tuning step frequency 1MHz

of Baseband(=I/Q out) LPF

1-7. Cutoff frequency Variable from 10MHz to 34MHz by 2MHz step

1-8. LINK IC STB0899 (Address: D0h)

(Reference clock: 4MHz supplied from "IX2470VA")

1-9. System clock specification  $F_{sampling} = F_{M\_CLK} = 99MHz$ 

1-10. Multistandard demodulation [DVB-S]

and decoding >Channel symbol rate up to QPSK 45MSps

>Inner Viterbi and Outer Reed-solomon decoding

>Punctured rates 1/2, 2/3, 3/4, 5/6, 6/7, 7/8

[DVB-S2]

>Channel symbol rates up to QPSK 36MSps,

and 8PSK 30MSps

>Inner LDPC and outer BCH decoding

>Punctured rates 1/2, 3/5, 2/3, 3/4, 4/5, 5/6, 8/9, 9/10

1-11. Operating voltage (B2, B3 and B4) 3.3V +/- 0.165V DC

(VDD) 1.8V +/- 0.090V DC

1-12. Storage condition Temperature 15 deg.C to 35 deg.C

Humidity 25 %RH to 75 %RH

Period 6 months

1-13. Environmental characteristics RoHS compliant

(RoHS refers to the "DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic

equipment.")

MODEL No.	SPEC No.	PAGE
BS2F7VZ0164	EC-06X02	4/19

### 1-14. Attention items:

 This unit contains components that can be damaged by electro-static discharge.
 Before handling this unit, ground your hands, tools, working desks and equipment to protect the unit from Electronic Static Destroy.

2) Avoid following actions;

a) to store this unit in the place of the high temperature and humidity.

b) to expose this unit to corrosive gases.

[2] MECHANICAL SPECIFICATION

2-1. Dimension and mounting details see section [14]

2-2. Mass 44g (typical)

2-3. Strength of F-connector No severe transform or distortion at bending moment,

0.98N·m. To be connected electrically.

2-4. Clamp Torque of F-connector No severe transform or distortion on the connection with

F-connector at bending moment, 0.98N·m.

To be connected electrically.

[3] ENVIRONMENTAL SPECIFICATION

(ELECTRICAL FUNCTIONAL OPERATION GUARANTEE)

3-1. Operating Temperature 0deg.C to +50deg.C

Humidity Less than 85%

No condensation

3-2. Storage Temperature -20deg.C to +85deg.C

Humidity Less than 95%

Water vapor pressure 6643Pa max, without condensation

<Notice>

Please be careful that sudden temperature changes may cause condensation during storage, and such condensation may cause corrosion.

### [4] ABSOLUTE MAXIMUM VOLTAGE

Pin name	Pin No.	MIN.	MAX	UNIT	Note
B1B	1		25	V	400mA max.
B1A	2		25	V	400mA max.
B4	3	-0.3	3.63	V	
B2	4	-0.3	4.0	V	
B3	11	-0.25	3.63	V	
VDD	13	-0.1	2.0	V	
SDA, SCL, RESETB	8, 9, 26	-0.3	B3+0.3	V	

MODEL No.	SPEC No.	PAGE
BS2F7VZ0164	EC-06X02	5/19

## [5] TESTING CONDITION

5-1. Supply voltage

Pin name	Pin No.	MIN.	TYP.	MAX.	UNIT	Note
B4	3	3.25	3.30	3.35	V	
B2	4	3.25	3.30	3.35	V	
B3	11	3.25	3.30	3.35	V	
VDD	13	1.77	1.80	1.83	V	

5-2. Ambient temperature 25deg.C +/- 5deg.C

5-3. Ambient humidity 65% +/- 10%

[6] ELECTRICAL SPECIFICATION (Unless otherwise stated testing condition 5-1 ~ 5-3.)

	LOTRICAL SI LOII	10/11/014	( Officac	Out ICI WIS	11d1tio11 3-1 3-3. )		
No.	Item	1		Specif	ication		Condition
		MIN.	TYP.	MAX.	UNIT		
6-1	RF input VSWR			2.0	2.5		950MHz to 2150MHz
6-2	Noise figure(at ma	ıx. gain)		8	12	dB	950MHz to 2150MHz
6-3	3 <sup>rd</sup> order Intermod Undesired signal ( (F <sub>D</sub> +29.5MHz, F <sub>D</sub> + (F <sub>D</sub> -29.5MHz, F <sub>D</sub> -	2 signals) ·59MHz) or	40	60		dB	Input level: -25dBm I/Q amplitude: 0.6V <sub>P-P</sub> BBLPF Fc=30MHz
6-4	L.O. leak at input t			-68	-63	dBm	950MHz to 2150MHz
6-5	PLL synthesizer tu	ning time		10	50	ms	limited to IX2470VA
6-6	PLL phase noise			-80	-70	dBc/Hz	10kHz offset
				-91	-86	dBc/Hz	100kHz offset
6-7	PLL reference leal	<		-40	-30	dBc	1MHz
6-8	RF output VSWR			2.0	2.5		950MHz to 2150MHz
6-9	RF output gain		-5	0	+5	dB	measured at RF out
6-10	Current	B2		90	135	mA	3.3V
	consumption	B3		70	130	mA	3.3V
		B4		25	40	mA	3.3V
		VDD		1200	1800	mA	1.8V

## [7] ERROR RATE PERFORMANCE

Es/No performance at Quasi Error Free

Mode	ETSI Ideal	Performance (Typical)	Unit	Note
QPSK 1/2	1.00	1.2		>DVB-S2
QPSK 3/5	2.23	2.4		>Pilot: ON
QPSK 2/3	3.10	3.2		>BW = Synbol_rate
QPSK 3/4	4.03	4.2		>BERTester: SFU
QPSK 4/5	4.68	4.8		
QPSK 5/6	5.18	5.3		
QPSK 8/9	6.20	6.4	dB	
QPSK 9/10	6.42	6.6	ub	
8PSK 3/5	5.50	5.8		
8PSK 2/3	6.62	6.8		
8PSK 3/4	7.91	8.1		
8PSK 5/6	9.35	9.6		
8PSK 8/9	10.69	10.9	]	
8PSK 9/10	10.98	11.3		

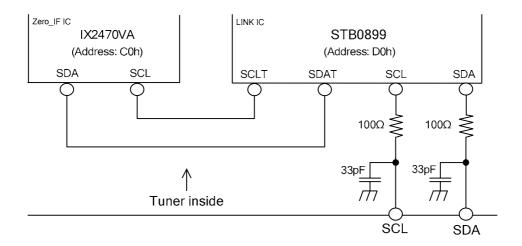
MODEL No. SPEC No. PAGE EC-06X02 6/19

# SHARP

# [8] I<sup>2</sup>C INTERFACE

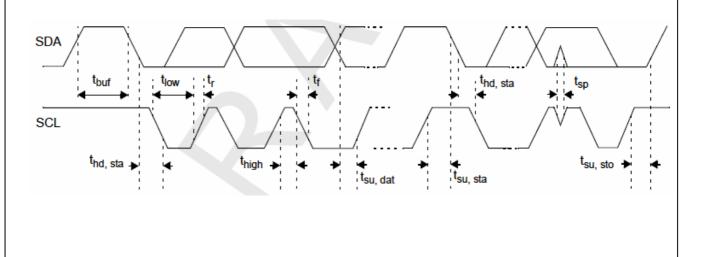
### 8-1. Internal circuits

The interface of this tuner is as following figure. It is using the I<sup>2</sup>C private repeater of STB0899 for tuner isolation.



## 8-2. I2C bus characteristic (conforms to the specification of STB0899)

Item	Synbol	MIN.	MAX.	Únit	Note
Input high voltage	V <sub>ih</sub>	2.0	3.6	V	
Input low voltage	V <sub>il</sub>	-0.5	0.8	V	
SCL clock rate	f <sub>scl</sub>		400	kHz	Normal mode
Bus free time between a stop and start condition	t <sub>buf</sub>	1.3		us	
Hold time (repeated) start condition	t <sub>hd, sta</sub>	0.6		us	After this period, the first clock pulse is generated.
Low period of the SCL	t <sub>low</sub>	1.3		us	
High period of the SCL	t <sub>high</sub>	0.6		us	
Rise time for SDA and SCL	t <sub>r</sub>		300	ns	Fast mode
Fall time for SDA and SCL	t <sub>f</sub>		300	ns	Fast mode
Setup time for a repeated start condition	t <sub>su</sub> , <sub>sta</sub>	0.6		us	
Setup time for stop condition	t <sub>su, sto</sub>	0.6		us	
Data setup time	t <sub>su</sub> , <sub>dat</sub>	100		ns	
Pulse width of spikes to be suppressed by input filter	t <sub>sp</sub>		50	ns	Fast mode



MODEL No.	SPEC No.	PAGE
BS2F7VZ0164	EC-06X02	7/19

### [9] IX2470VA FUNCTIONAL DESCRIPTION

PLL and VCO are promptly set up without fail when the user correctly program the data with the prompt I<sup>2</sup>C access sequence as long as the following are also applied;

- a) Follow the I<sup>2</sup>C standard specification
- b) Leave RTS to 0

### 9-1. I<sup>2</sup>C-BUS DATA FORMATS

Table 1; Write data format (MSB is transmitted first)

IVIS	В							LSB		
1		1	0	0	0	0(MA1)	0(MA0)	0	Α	Byte1
0		1(BG1)	0(BG0)	N8	N7	N6	N5	N4	Α	Byte2
N;	3	N2	N1	A5	A4	A3	A2	A1	Α	Byte3
1		1(C1)	1(C0)	PD5	PD4	TM	0(RTS)	REF	Α	Byte4
ВА	.2	BA1	BA0	PSC	PD3	PD2/TS2	DIV/TS1	PD0/TS0	Α	Byte5

\* A ; Acknowledge bit

; Programmable division ratio control bits \* N8 to N1 (see Table 3) \* A5 to A1 ; Swallow division ratio setting bits (see Table 4) \* REF ; Reference division ratio setting bits (see Table 5) \* PSC ; Prescaler division ratio setting bits (see Table 6) \* MA1, MA0 ; Address setting bits (see Table 7) \* PD0 : PO control bit (see Table 8) \* BA2, BA1, BA0 ; Local oscillator select (see Table 9)

\* DIV ; Local oscillator divided ratio setting

\* PD5 to PD2 ; BB LPF cut-off frequency setting (see Table 10)
\* RTS ; Test mode control bit (see Table 11)

\* TS2, TS1, TS0 ; Test mode setting bits (when RTS = '1')

\* C1, C0 ; Charge pump current setting bits (see Table 12)

\* BG1, BG0 ; BB AMP gain setting bits (see Table 13)

\* TM ; VCO/LPF adjustment mode setting bits (see section 9-3)

Write PLL register data to set one among the following I<sup>2</sup>C access sequence as #a) to h). It is available to skip the bytes which does not require for renewal or change the sequence of the bytes to choose one of the following.

I<sup>2</sup>C start->1<sup>st</sup> byte->2<sup>nd</sup> byte->3<sup>rd</sup> byte->4<sup>th</sup> byte->5<sup>th</sup> byte

- a) I<sup>2</sup>C start -> byte1 -> byte2 -> byte3 -> byte4 -> byte5 \* byte1: I<sup>2</sup>C address byte
- b) I<sup>2</sup>C start -> byte1 -> byte4 -> byte5 -> byte2 -> byte3 \*
- c) I<sup>2</sup>C start -> byte1 -> byte2 -> byte3 -> byte4 -> either I<sup>2</sup>C stop or (another) start
- d) I<sup>2</sup>C start -> byte1 -> byte4 -> byte5 -> byte2 -> either I<sup>2</sup>C stop or (another) start
- e) I<sup>2</sup>C start -> byte1 -> byte2 -> byte3 -> either I<sup>2</sup>C stop or (another) start
- f) I<sup>2</sup>C start -> byte1 -> byte4 -> byte5 -> either I<sup>2</sup>C stop or (another) start
- g) I<sup>2</sup>C start -> byte1 -> byte2 -> either I<sup>2</sup>C stop or (another) start
- h) I<sup>2</sup>C start -> byte1 -> byte4 -> either I<sup>2</sup>C stop or (another) start
- \*: Either I<sup>2</sup>C stop or (another) start is available to follow after the 5<sup>th</sup> byte, but not mandatory

CAUTION: During receiving signals, don't access I<sup>2</sup>C bus to satisfy the phase noise character specification.

MODEL No. SPEC No. **PAGE** BS2F7VZ0164 EC-06X02 8/19

# SHARP

#### NOTE: PLL set up rules

The following conditions are required to program the I<sup>2</sup>C access sequence.

According to a required renewal data on each byte, one of the access sequence shown above as a) to h) should be chosen.

- 1) Write byte1 on the 1<sup>st</sup> byte after I<sup>2</sup>C start.

2) Write either byte2 or byte4 on the 2<sup>nd</sup> byte.

When the MSB header is 0 on the 2<sup>nd</sup> byte, the 2<sup>nd</sup> byte is recognized as byte2.

When the MSB header is 1 on the 2<sup>nd</sup> byte, the 2<sup>nd</sup> byte is recognized as byte4.

3) The following byte after byte2 or byte4 should be the sequent # of the last byte as;

The byte3 should be followed after byte2.

The byte5 should be followed after byte4.

- 4) The number of byte to write in one access sequence as from a start to a stop (or another start) state should be two bytes at least. Review #g) and #h). Maximum bytes are five as write all byte1 to byte5 data in one access sequence. Review #a) and #b)
- 5) The renewal of the register data is only available when it becomes an I<sup>2</sup>C stop or another start state after all the bytes to write in case of #c) to h). Only in the case when the renewal of the register data all from byte2 to byte5 in one access sequence as #a) and #b), a stop state or another start state is not mandatory required for data renewal.
- 6) The data already registered and not to write for renewal has kept as it is as the last state.
- 7) Every time when the power is on, write all the register data on byte2 to byte5 in one sequence for the purpose of the initial default set up to follow either #a) or #b). Because the initial values on byte2 to byte5 are not fixed before the initialization.
- 8) As for POR (POWER ON RESET) of this tuner, the rise of the power-supply voltage might not operate normally when it is not linear, and the noise enters while the power-supply voltage is rising For this case, the tuner might not accept the data input (Ack is not returned). Please input data again (re-try) for this case.

Table 2; Read data format

MSB							LSB		
1	1	0	0	0	MA1	MA0	1	Α	Byte1
POR	FL	RD2	RD1	RD1	Х	Х	Х	Α	Byte2

\* POR ; Power on reset indicator (see table 14) \* FL ; Phase lock detect flag (see table 15)

\* RD2 – RD0 ; Reserved (These bit values change under the condition of ICs.)

\* X ; don't care

\* All data of byte2 will be "H", when "Power on reset" operates under the condition of a pulled up SDA

\* "Read mode" will change to "Write mode" after completing to output the byte2.

#### 9-2. PROGRAMING

9-2-1 Programmable divider bits data

Please set P, N, A, R as follows.

### $\underline{\text{fvco}} = [(P * N) + A] * \underline{\text{fosc}} / R$

fvco: Receiving frequency

: Dividing factor of prescaler (16 or 32) : Programmable division ratio (5 to 255) : Swallow division ratio (0 to 31 and A < N) fosc: Reference oscillation frequency (4 MHz) : Reference division ratio (see table 5)

MODEL No.	SPEC No.	PAGE
BS2F7VZ0164	EC-06X02	9/19

#### 9-2-2 Data setting

Table 3; Programmable division ratio control (Binary: 8 bits)

Dividing		Bit data						
factor (N)	N8	N7	N6	N5	N4	N3	N2	N1
5	0	0	0	0	0	1	0	1
6	0	0	0	0	0	1	1	0
•	•	•	•	•	•	•	•	•
255	1	1	1	1	1	1	1	1

Table 4; Swallow division ratio setting (Binary: 5 bits)

Dividing	Bit data					
factor (A)	A5	A4	А3	A2	A1	
0	0	0	0	0	0	
1	0	0	0	0	1	
•	•	•	•	•	•	
31	1	1	1	1	1	

<sup>\*</sup> The using of 4 or smaller dividing factors is inhibited.

Table 5; Reference division ratio setting (Binary: 1 bit)

	REF	Dividing factor (R)	Compare frequency	fvco(MHz)	
I	0	4	1 MHz	1024 – 2150 MHz*	Caution:
Ī	1	8	500 KHz	950 – 2150 MHz	Only use REF=0

<sup>\*</sup> When the reference division ratio set to 4(REF = '0'), the fvco's minimum frequency must be higher than 1024 MHz (including 1024 MHz). If the frequency is lower than 1023 MHz, the condition mentioned in section 6-2-1 "A < N" is not satisfied. But all receiving ranges can be covered with combination with PSC setting. (see Table 6)

Table 6; Prescaler division ratio setting (Binary: 1 bit)

PSC	Dividing factor (P)	fvco
0	32	950 – 2150 MHz
1	16	950 – 1375 MHz*

The dividing factor is set by PSC in byte 4 on  $I^2C$  write data.

Table 7; Address selection (Binary: 2 bits)

Bit					
MA1	MA0	ADR input voltage			
0	0	0V ~ 0.1VCC			
0	1	open			
1	0	0.4VCC ~ 0.6VCC			
1	1	0.9VCC ~ VCC			

Table 8; PO control (Binary: 1 bit)

Bit	Output of PO				
PD0	Normal	Power on	Power on		
1	L	Hi-Z	Hi-Z		
0	Hi-Z	Hi-Z			

<sup>\*</sup> Hi-Z: High impedance

<sup>\*</sup> The dividing factor is set by the data of N8 to N1 and A5 to A1 in byte2, 3 on I<sup>2</sup>C write data. (table 1)

<sup>\*</sup> When the prescaler division ratio of the prescaler is set to 16(PSC = '1'), the fvco's maximum frequency must be lower than 1375 MHz (including 1375 MHz). This fvco's maximum frequency limitation is depended on the operation frequency of the internal programmable counter. Refer to Table 9 about PSC detailed setting.

Table 9; Local oscillator select (Binary: 4 bits)

	Byte 4		Byte 5					
		PSC					VCO	Local frequency
BAND	PSC	div.ratio	DIV	BA2	BA1	BA0	div.ratio	(Receiving frequency)
1	1	1/16	1	1	0	1	1/4	950 ~ 986 MHz
2	1	1/16	1	1	1	0	1/4	986 ~ 1073 MHz
3	0	1/32	1	1	1	1	1/4	1073 ~ 1154 MHz
4	0	1/32	0	0	0	1	1/2	1154 ~ 1291 MHz
5	0	1/32	0	0	1	0	1/2	1291 ~ 1447 MHz
6	0	1/32	0	0	1	1	1/2	1447 ~ 1615 MHz
7	0	1/32	0	1	0	0	1/2	1615 ~ 1791 MHz
8	0	1/32	0	1	0	1	1/2	1791 ~ 1972 MHz
9	0	1/32	0	1	1	0	1/2	1972 ~ 2150 MHz
-	0	1/32	0/1	0	0	0	_	VCO disable

Table 10: Baseband LPF cut-off frequency setting

Register Bit LPF cut-off								
PD2	PD3	PD4	PD5	Frequency				
0	0	1	1	10 MHz				
0	1	0	0	12 MHz				
0	1	0	1	14 MHz				
0	1	1	0	16 MHz				
0	1	1	1	18 MHz				
1	0	0	0	20 MHz				
1	0	0	1	22 MHz				
1	0	1	0	24 MHz				
1	0	1	1	26 MHz				
1	1	0	0	28 MHz				
1	1	0	1	30 MHz				
1	1	1	0	32 MHz				
1	1	1	1	34 MHz				

Table 11; Test mode setting

	Regist	Toot made		
RTS	TS2	TS2 TS1 TS		Test mode
0	Х	X X X		Normal operation
1		Don'	t use	Reserved (Test Mode)

X: don't care

<sup>\*</sup> When RTS=1 on "I<sup>2</sup>C write data (table 1)", it changes to test mode.

MODEL No.	SPEC No.	PAGE
BS2F7VZ0164	EC-06X02	11/19



Table 12; Charge pump output current selection

Е	Bit	Charge p	Charge pump output current [µA]		
C1	C0	min	typ	max	
0	0	±78	±120	±150	
0	1	±169	±260	±325	
1	0	±360	±555	±694	
1	1	±780	±1200	±1500	

Table 13; Baseband AMP gain control (Depend on PLL register setting)

BG1	BG0	ATTENUATION (Typ.)
0	0/1	0
1	0	–2 dB
1	1	−4 dB

<sup>\*</sup> Set BG1,BG0 as 1,0.

Table 14; POR bit polarity

	VCC > 2.2V	VCC < 2.2V
POR bit	L	Н

<sup>\*</sup> SDA has to be pulled up.

Table 15; FL bit polarity

	lock	unlock
FL bit	Н	L

MODEL No. SPEC No. **PAGE** 12/19 BS2F7VZ0164 EC-06X02 SHARP 9-3. Tuner control procedure VCO and LPF adjustment mode setting sequence after power on **START** I<sup>2</sup>C Start Byte1 Set the MA1, MA0 bits (Slave address setting) Wait for 10msec Byte2 Hardware adjustment Set MSB header bit to '0' mode running (Byte2 header bit data) I<sup>2</sup>C Start Set BG1, BG0 bit Byte1 (BB AMP gain setting) Set the MA1, MA0 bits Set the N8-N4 bits (Slave address setting) (Programmable division ratio control) Byte4 Set MSB header bit to '1' Set the N3-N1 bits (Byte4 header bit data) (Programmable division ratio control) Set the PD5 and PD4 bits Set the A5-A1 bits (BB LPF cut-off frequency setting) (Swallow division ratio setting) Leave the TM bit to '1' Byte4 (VCO/LPF adjustment mode setting) Set MSB header bit to '1' Leave the latest data (Byte4 header bit data) (C1, C0, RTS, REF) Set the PD5 and PD4 bits to '0' Byte5 (BB LPF cut-off frequency setting) Set the PD3 and PD2 bits Set the TM bit to '0' (BB LPF cut-off frequency setting) (VCO/LPF adjustment mode clear) Leave the latest data Leave the latest data (BA2-BA0, PSC, DIV, PD0) (C1, C0, RTS, REF) Byte5 I<sup>2</sup>C Stop Set the BA2-BA0 bits **END** (Local oscillator select) Set the PD3 and PD2 bits to '0' (BB LPF cut-off frequency setting) Set the DIV bit (Local oscillator divided ratio setting) Leave the latest data (PSC, PD0) (I<sup>2</sup>C Stop) I<sup>2</sup>C Start Set the MA1, MA0 bits (Slave address setting) Byte4 Set MSB header bit to '1' (Byte4 header bit data) Set the TM bit to '1' (VCO/LPF adjustment mode setting) Leave the latest data (C1, C0, PD5, PD4, RTS, REF) I<sup>2</sup>C Stop

MODEL No. SPEC No. PAGE EC-06X02 13/19

# SHARP

### [10] Reliability

- 10-1. High temperature high humidity load (40deg.C, 90% RH, 500h)
  - After leaving DUT at room temperature and humidity for 24h or longer, measure the initial value.
  - 2) After cycling DUT in the constant chamber at 40deg.C/90-95% RH in on state, for total 500h, leave the DUT at room temperature and humidity for 2h and then measure value after test.
  - 3) Must meet the specifications of Table 17.
  - 4) The contact resistance of F-connector must be less than 0.02 ohm. (\*)
- 10-2. High temperature load (70deg.C, 40% RH, 500h)
  - 1) After leaving DUT at room temperature and humidity for 24h or longer, measure the initial value.
  - 2) After leaving DUT in the constant chamber at 70+/-2deg.C/40% RH for total 500h, leave the DUT at room temperature and humidity for 2h and then measure value after test.
  - 3) Must meet the specifications of Table 17.
- 10-3. Cold test (-25deg.C, 500h)
  - 1) After leaving DUT at room temperature and humidity for 24h or longer, measure the initial value.
  - 2) After leaving DUT in the constant temperature chamber at -25deg.C for 500h, leave the DUT at room temperature and humidity for 2h and then measure the values after test.
  - 3) Must meet the specifications of Table 17.
- 10-4. Shock (686 m/s<sup>2</sup>, 6 planes, 3 times)
  - 1) After leaving DUT at room temperature and humidity for 24h or longer, measure the initial values.
  - 2) Using the shock tester, apply shock of 686 m/s<sup>2</sup> three times to each of 6 planes and then measure the values.
  - 3) Must meet the specifications of Table 17.
  - 4) This test is to be conducted using a single tuner.
- 10-5. Vibration (10-55 Hz, 1.5 mm, in each of three mutually perpendicular directions, each 2 times)
  - 1) After leaving DUT at room temperature and humidity for 24h or longer, measure the initial values.
  - 2) Using the vibration tester, apply motion having an amplitude of 1.5 mm (constant), the frequency being varied uniformly between 10 and 55 Hz, to DUT, for 2h in each of three mutually perpendicular directions (X, Y and Z, total of 6h). After the test, measure the values.
  - Must meet the specifications of Table 17.
  - 4) This test is to be conducted using a single tuner.
- 10-6. Heat shock test (1 cycle=1h (-20deg.C; 0.5h, 70deg.C;0.5h), 50 cycles))
  - 1) After leaving DUT at room temperature and humidity for 24h or longer, measure the initial value
  - 2) Using the heat shock tester, apply heat shock to DUT. After the test, measure the values.
  - 3) Must meet the specifications of Table 17.
  - 4) The contact resistance of F-connector must be less than 0.02 ohm. (\*)

### 10-7. Solderability of terminal

Pretreatment of heating terminal at 150deg.C for 1h is performed and leave it at room temperature for 2h or longer. Immerse 1.9 mm length of terminal (from the tip) to be soldered into rosin (JIS-K-5902), isopropyl alcohol (JIS-K-8839 or JIS-K-1522, rosin concentration (10-35% range) approx. 25% by weight unless otherwise specified) or equivalent solution for 3–5s, and then immerse the length of the terminal into a pool of molten solder (Sn/3.0Ag/0.5Cu, or equivalent) at 240 +/-2deg.C for 3s.Dipped terminal portion shall be wetted by more than 95%. (Excluding the cutting plane of the chassis)

MODEL No.	SPEC No.	PAGE
BS2F7VZ0164	EC-06X02	14/19

### 10-8. Soldering heat resistance

Immerse the terminal mounted on a PCB (1.6t thick) into solder at 350±5deg.C for 3.0-3.5 seconds or at 260 +/-5deg.C for 10 +/-1 seconds. Remove the PCB from the solder and leave it for 1 hour at room temperature. The test sample shall show no degradation in appearance and electrical characteristics.

## 10-9. ESD protection

Table 16: ESD Test Condition (IEC61000-4-2 Compliant)

· · · · · · · · · · · · · · · · · · ·				
Terminal	Limits	Condition		
RF_IN	+/-6kV DC	150pF/330ohm		
(coaxial center)		each 5 times		
Others	+/-200V DC	150pF/330ohm		
		each 5 times		

#### Table 17

No.	Item		(	Spec.	UNIT	Condition
10-1	Noise figure(at max. gain)		٧	12	dB	950MHz to 2150MHz
10-2	PLL phase noise		<	-70	dBc/Hz	10kHz offset
			<	-86	dBc/Hz	100kHz offset
10-3	Current	B2	<	135	mA	3.3V
	consumption	B3	<	130	mA	3.3V
		B4	<	40	mA	3.3V
		VDD	< ′	1800	mA	1.8V
10-4	Es/No at QEF	8PSK 3/4	<	8.2	dB	DVB-S2, Pilot: ON

### (\*)Method of measuring contact resistance

### **Center-contact**

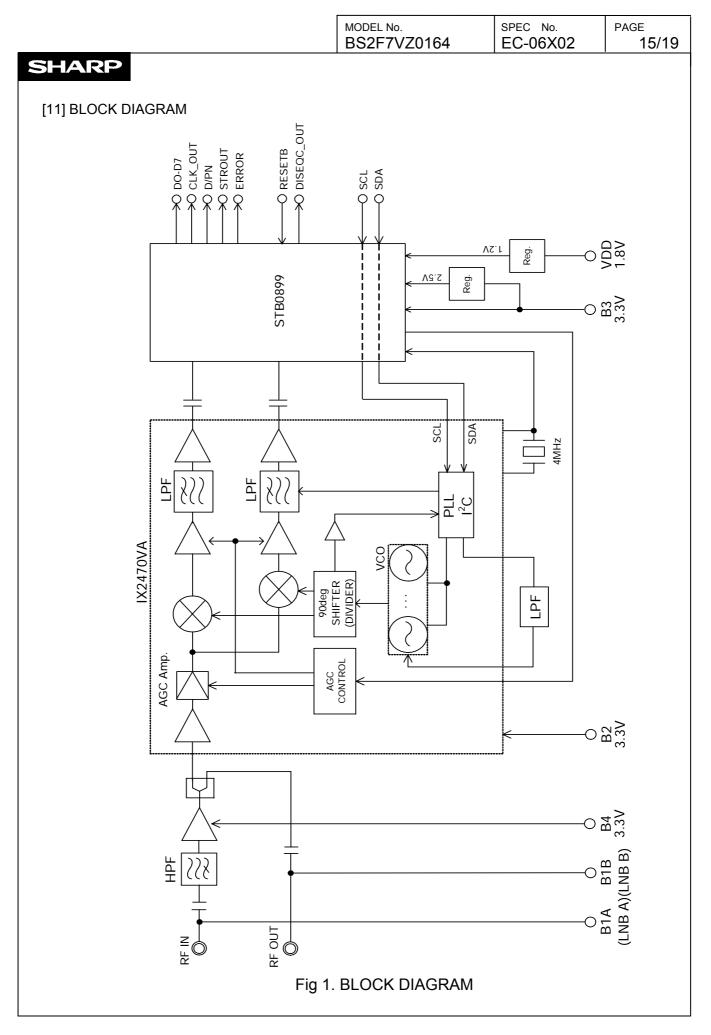
Insert the gauge  $pin(\phi 0.8mm)$  to F-connector.

Measure the resistance between the gauge and the center-contact of F-connector.

#### Outer-shell

Connect the plug(3/8-32 UNEF-2B) to F-connector at 29.4N• cm of the clamping torque. Measure the resistance between the plug and chassis.

(Measuring device: Milliohm meter)



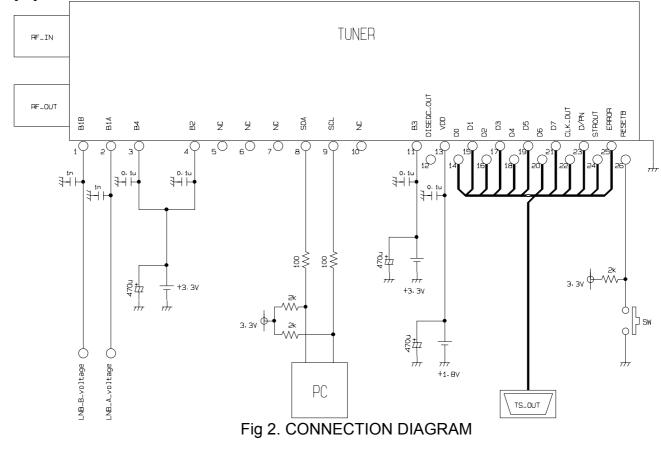
MODEL No. SPEC No. PAGE EC-06X02 16/19

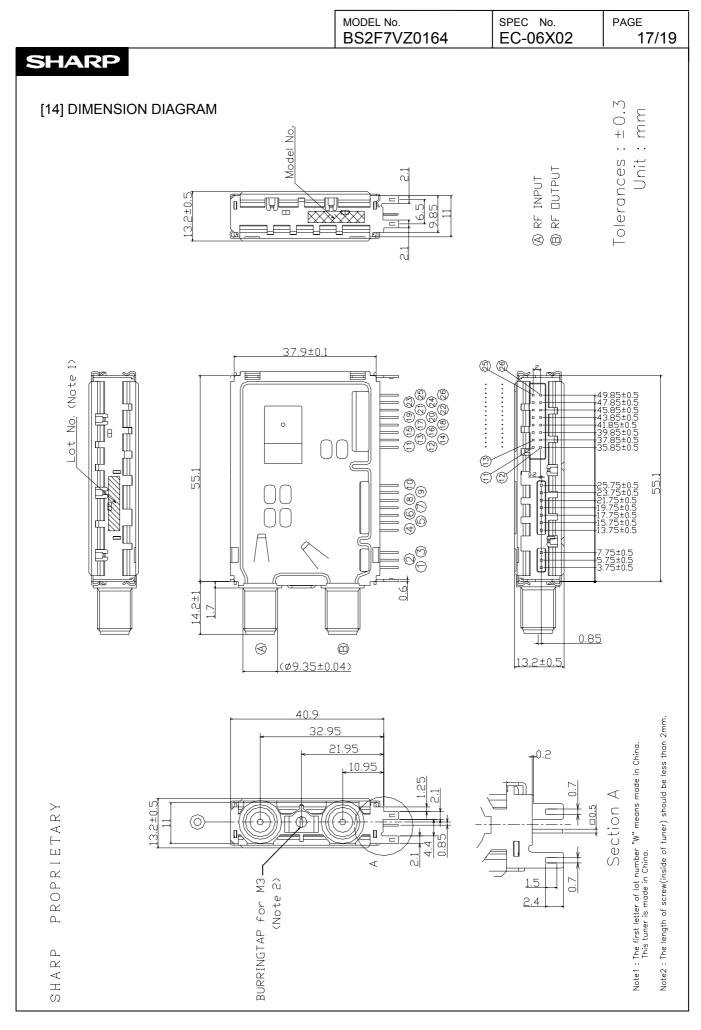
# SHARP

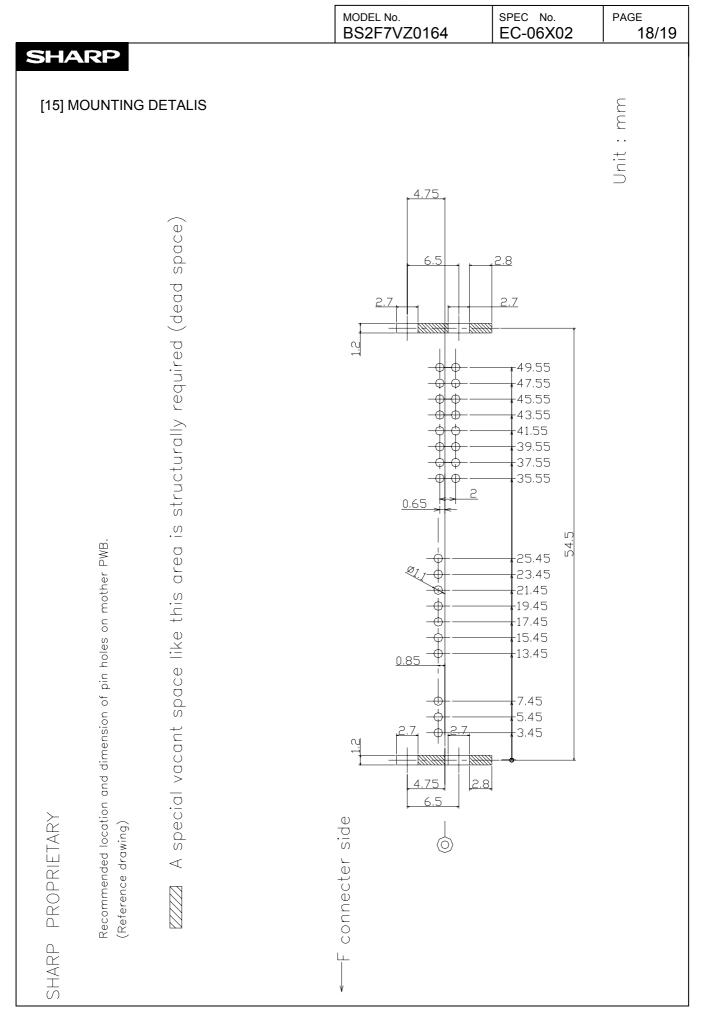
[12] PIN LIST

[ 1 Z ] 1 11 V Z		T	
No.	NAME	LOGIC	PIN DESCRIPTION
1	B1B		Voltage supply of LNB B. Please ground it with a 1000pF ceramic
			capacitor.
2	B1A		Voltage supply of LNB A. Please ground it with a 1000pF ceramic
			capacitor.
3	B4		3.3V supply for RF Booster Amp of tuner.
4	B2		3.3V supply for the Front-end section. Please keep a ripple at the Power
			Supply less than 10mVp-p.
5,6,7,10	NC		It is not connected inside the unit. We advice to ground it.
8	SDA	3.3V	I <sup>2</sup> C Bus. Please connect a pull-up resistor which is more than 2k ohm
9	SCL	3.3V	outside of the tuner.
11	B3		3.3V supply for demodulator IC. It is internally converted into 2.5V.
12	DISEQC_	3.3V	Digital satellite equipment control output.
	OUT		
13	VDD		1.8V digital core supply. It is internally converted into 1.2V.
14,,21	D0,,D7	3.3V	Transport stream parallel data.
22	CLK_OUT	3.3V	Transport stream byte or bit clock.
23	D/PN	3.3V	Transport stream data valid signal.
24	STROUT	3.3V	Transport stream sync bit.
25	ERROR	3.3V	Transport stream packet error signal.
26	RESETB	3.3V	Reset signal active low.
			· -









MODEL No. SPEC No. PAGE BS2F7VZ0164 EC-06X02 19/19 SHARP [16] PACKAGEING DETAILS pad ×3 partition\_B x12 partition\_C x12 partition\_A x42 frame x2 outer\_box x1 antistatic\_sheet x1 Unit:mm Quantity: 200pcs